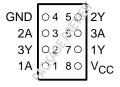
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- **Available in the Texas Instruments** NanoStar™ and NanoFree™ Packages
- Supports 5-V V_{CC} Operation
- Inputs Accept Voltages to 5.5 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) >2 V at $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Ioff Feature Supports Partial-Power-Down **Mode Operation**
- Latch-Up Performance Exceeds 100 mA Per **JESD 78, Class II**
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DCT OR DCU PACKAGE (TOP VIEW) ∏ V_{CC} 3Y 🛮 **∏** 1Y 2A [**1** 3A 3 6 GND [7 2Y

YEA OR YZA PACKAGE (BOTTOM VIEW)



description/ordering information

This triple Schmitt-trigger inverter is designed for 1.65-V to 5.5-V V_{CC} operation.

The SN74LVC3G14 contains three inverters and performs the Boolean function $Y = \overline{A}$. The device functions as three independent inverters but, because of Schmitt action, it may have different input threshold levels for positive-going (V_{T+}) and negative-going (V_{T-}) signals.

NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
	NanoStar™ WCSP (DSBGA) – YEA (Lead)	Tape and reel	SN74LVC3G14YEAR	CF_
-40°C to 85°C	NanoFree™ WCSP (DSBGA) – YZA (Lead-free)	Tape and reel	SN74LVC3G14YZAR	OF_
	SSOP - DCT	Tape and reel	SN74LVC3G14DCTR	C14
	VSSOP – DCU	Tape and reel	SN74LVC3G14DCUR	C14_

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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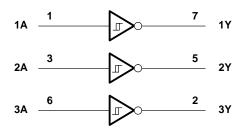


DCT: The actual top-side marking has three additional characters that designate the year, month, and assembly/test site. DCU: The actual top-side marking has one additional character that designates the assembly/test site. YEA/YZA: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site.

FUNCTION TABLE (each inverter)

INPUT A	OUTPUT Y
Н	L
L	Н

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}	
(see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I_{OK} ($V_O < 0$)	
Continuous output current, IO	±50 mA
Continuous current through V _{CC} or GND	±100 mA
Package thermal impedance, θ _{JA} (see Note 3): DCT package	220°C/W
DCU package	227°C/W
YEA/YZA package	
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The value of $V_{\hbox{\scriptsize CC}}$ is provided in the recommended operating conditions table.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
V	Cumphyvoltogo	Operating	1.65	5.5	V
VCC	Supply voltage	Data retention only	1.5		V
٧ _I	Input voltage		0	5.5	V
٧o	Output voltage		0	VCC	V
		V _{CC} = 1.65 V		-4	
	High-level output current	$V_{CC} = 2.3 \text{ V}$		-8	
loh		V3V		-16	mA
		VCC = 3 V		-24	
		V _{CC} = 4.5 V		-32	
		V _{CC} = 1.65 V		4	
		V _{CC} = 2.3 V			
I_{OL}	Low-level output current	V 3 V		16	mA
		VCC = 3 V		24	
		$V_{CC} = 4.5 \text{ V}$		32	
TA	Operating free-air temperature		-40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	vcc	MIN	TYPT MAX	UNIT
		1.65 V	0.7	1.4	
V _{T+}		2.3 V	1	1.7	
Positive-going input		3 V	1.3	2.2	V
threshold voltage		4.5 V	1.9	3.1	
		5.5 V	2.2	3.7	
		1.65 V	0.3	0.7	
V _T _		2.3 V	0.4	1	
Negative-going input		3 V	0.6	1.3	V
threshold voltage		4.5 V	1.1	2	
		5.5 V	1.4	2.5	
		1.65 V	0.3	0.8	
ΔV_{T}		2.3 V	0.4	0.9	
Hysteresis (V _{T+} - V _{T-})		3 V	0.4	1.1	V
		4.5 V	0.6	1.3	
		5.5 V	0.7	1.4	
	$I_{OH} = -100 \mu A$	1.65 V to 4.5 V	V _{CC} -0.1		
	I _{OH} = -4 mA	1.65 V	1.2		
\/	$I_{OH} = -8 \text{ mA}$	2.3 V	1.9		V
VOH	I _{OH} = -16 mA	3 V	2.4		V
	I _{OH} = -24 mA	3 V	2.3		
	$I_{OH} = -32 \text{ mA}$	4.5 V	3.8		
	I _{OL} = 100 μA	1.65 V to 4.5 V		0.1	
	I _{OL} = 4 mA	1.65 V		0.45	
\/a-	I _{OL} = 8 mA	2.3 V		0.3	V
VOL	I _{OL} = 16 mA	3 V		0.4	V
	I _{OL} = 24 mA	3 V		0.55	
	I _{OL} = 32 mA	4.5 V		0.55	
I _I A inputs	V _I = 5.5 V or GND	0 to 5.5 V		±5	μΑ
l _{off}	V_I or $V_O = 5.5 \text{ V}$	0		±10	μΑ
Icc	$V_I = 5.5 \text{ V or GND}, \qquad I_O = 0$	1.65 V to 5.5 V		10	μΑ
ΔlCC	One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND	3 V to 5.5 V		500	μΑ
C _i	V _I = V _{CC} or GND	3.3 V		4.5	pF

 $[\]dagger$ All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PAI	RAMETER	FROM TO (INPUT) (OUTPUT)		V _{CC} = ± 0.1		V _{CC} =		V _{CC} =		= V _{CC} ± 0.		UNIT
	(INFO1)	(0011 01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
	^t pd	Α	Υ	3.9	9.2	1.9	5.7	2.3	5.4	1.5	4.3	ns



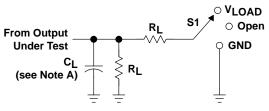
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operating characteristics, $T_A = 25^{\circ}C$

PARAMETER		TEST CONDITIONS	V _{CC} = 1.8 V	V _{CC} = 2.5 V	V _{CC} = 3.3 V	V _{CC} = 5 V	UNIT
		TEST CONDITIONS	TYP	TYP	TYP	TYP	UNIT
C _{pd}	Power dissipation capacitance	f = 10 MHz	17	18	19	22	pF

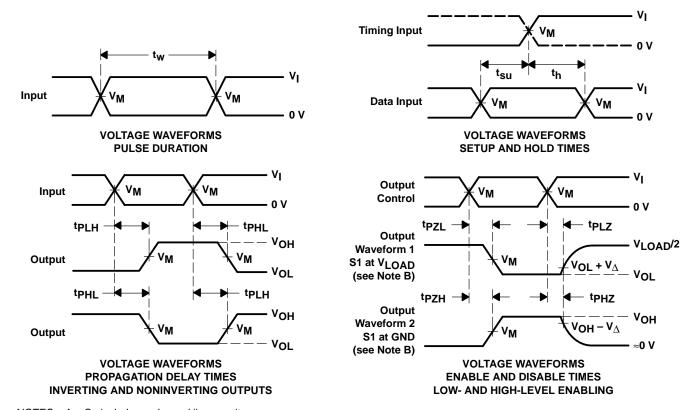
PARAMETER MEASUREMENT INFORMATION



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	VLOAD
tPHZ/tPZH	GND

	CIR	

.,	INPUTS					_	.,
VCC	٧ _I	t _r /t _f	VM	VLOAD	CL	RL	$v_{\scriptscriptstyle\Delta}$
1.8 V \pm 0.15 V	VCC	≤2 ns	V _{CC} /2	2×VCC	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	VCC	≤2 ns	V _{CC} /2	2×VCC	30 pF	500 Ω	0.15 V
3.3 V \pm 0.3 V	3 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
5 V \pm 0.5 V	VCC	≤2.5 ns	V _{CC} /2	2×V _{CC}	50 pF	500 Ω	0.3 V



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tplH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



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Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265

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